



## **Ceramic Heat Sink**

With Micro-pores structure, creates much larger surface area, provide excellent heat dissipation effect with smaller size.

*A new Thermal Solution*



### **Better Heat Radiation**

Micro-porous Ceramic Heat Sink is a porous material that has 30% more porosity. The surface area is much larger than metal material per unit area. Ceramic material does not store heat. Heat dissipation by radiation from the large surface area.

### **Very good Nature Heat Convection**

30% more porosity creates a much larger surface area than metal heat sink. More heat can dissipate in unit time by nature convection. It has insulation and EMI function.

### **No EMI Problem, since its Ceramic Construction**

MPC is a better heat dissipation solution than copper and aluminum heat sink per same unit volume. Also, there is no EMI interference.

***It is the best thermal solution  
for slim products designs.***

### **Application:**

- LED TV, LCD TV
- Notebook, ADSL
- M/B (Mother board)
- Power Transistor, Traic
- Power Module
- Chip IC

